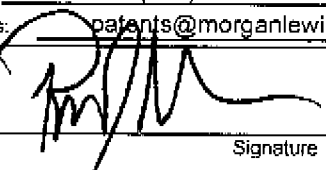


Form PTO-1595 (Rev. 08/08)  
OMB No. 0651-0027 (exp. 9/30/2008)

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## RECORDATION FORM COVER SHEET PATENTS ONLY

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

<b>1. Name of conveying party(ies):</b> Jae Hung CHUN Kyu Nam LEE Jae Won JEONG Ji Eun KIM Seon Kyu KIM  Additional name(s) of conveying party(ies) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No	<b>2. Name and address of receiving party(ies)</b> Name: <u>LG Electronics Inc.</u>  Internal Address: _____ Street Address: _____  20 Yeouido-dong, Yeongdeungpo-gu  City: <u>Seoul</u> State: _____ Country: <u>Republic of Korea</u> Zip: <u>150-721</u> Additional name(s) & address(es) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No
<b>3. Nature of conveyance/Execution Date(s):</b> Execution Date(s): <u>In parentheses after inventor name</u> <input checked="" type="checkbox"/> Assignment <input type="checkbox"/> Merger <input type="checkbox"/> Change of Name <input type="checkbox"/> Security Agreement <input type="checkbox"/> Joint Research Agreement <input type="checkbox"/> Government Interest Assignment <input type="checkbox"/> Executive Order 9424, Confirmatory License <input type="checkbox"/> Other _____	<b>4. Application or patent number(s):</b> <input type="checkbox"/> This document is being filed together with a new application. A. Patent Application No.(s) This application <u>29/331,267</u>  Additional numbers attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No
<b>5. Name and address to whom correspondence concerning document should be mailed:</b> Name: <u>ROBERT J. GAYBRICK</u> <u>MORGAN LEWIS &amp; BOCKIUS LLP</u>  Internal Address: <u>Atty. Dkt.: 041501-7039US</u> Street Address: <u>1111 Pennsylvania Ave NW</u>  City: <u>Washington</u> State: <u>DC</u> Zip: <u>20004</u> Phone Number: <u>(202) 739-3000</u> Fax Number: <u>(202) 739-3001</u> Email Address: <u>patents@morganlewis.com</u>	<b>6. Total number of applications and patents involved:</b> <span style="border: 1px solid black; padding: 2px 10px;">1</span>  <b>7. Total fee (37 CFR 1.21(h) &amp; 3.41)</b> \$ <u>40.00</u> <input type="checkbox"/> Authorized to be charged by credit card <input checked="" type="checkbox"/> Authorized to be charged to deposit account <input type="checkbox"/> Enclosed <input type="checkbox"/> None required (government interest not affecting title)
<b>8. Payment Information</b> a. Credit Card Last 4 Numbers _____ Expiration Date _____ b. Deposit Account Number <u>50-0310</u> Authorized User Name <u>Robert J Goodell</u>	
<b>9. Signature:</b> <div style="text-align: center;">         _____        Signature     </div> <div style="text-align: right; margin-top: 10px;"> <u>October 14, 2008</u>        Date     </div> <div style="text-align: center; margin-top: 10px;"> <u>Robert J. Goodell-41,040</u>        Name of Person Signing     </div> <div style="text-align: right; margin-top: 10px;">       Total number of pages including cover sheet, attachments, and documents: <span style="border: 1px solid black; padding: 2px 10px;">3</span> </div>	

CH \$40.00 600310 29331267

ATTORNEY DOCKET NO.:  
SOLE/JOINT INVENTION  
(U.S. Rights Only)

### ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

### DEHUMIDIFIER

for which I/WE executed an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on \_\_\_, (Application No. \_\_\_); and

WHEREAS, LG Electronics Inc., a corporation of Republic of Korea, whose post office address is 20, Yeouido-dong, Yeongdeungpo-gu, Seoul, Korea 150-721, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parenthesis (Application No. 29/331,267, filed 22 JAN 2009) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s).

Full Name of Sole or First Assignor Jae Hung CHUN	Assignor's Signature Jae Hung CHUN	Date January 19, 2009
Address Samsung Apt. 103-1502, Bongcheon-4-dong, Gwanak-gu, Seoul, Korea		Citizenship Republic of Korea
Full Name of Second Assignor Kyu Nam LEE	Assignor's Signature Kyu Nam LEE	Date January 19, 2009
Address Jugong 3cha Apt. 308-1902, Deokso-ri, Wabu-eup, Namyangju-si, Gyeonggi-do, Korea		Citizenship Republic of Korea
Names of additional inventors attached <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No		

Full Name of Third Assignor Jae Won JEONG	Assignor's Signature Jae Won JEONG	Date January 19, 2009
Address Sinsigaji-14-danji Apt. 1413-101, Sinjeong-6-dong, Yangcheon-gu, Seoul, Korea		Citizenship Republic of Korea
Full Name of Fourth Assignor Ji Eun KIM	Assignor's Signature Ji Eun KIM	Date January 19, 2009
Address Sangu Apt 101-1801, Gaebong-2-dong, Guro-gu, Seoul, Korea		Citizenship Republic of Korea
Full Name of Fifth Assignor Seon Kyu KIM	Assignor's Signature Seon Kyu KIM	Date January 19, 2009
Address Heunghwa Brown Apt. 101-701, 930-1, Bangbae-1-dong, Seocho-gu, Seoul, Korea		Citizenship Republic of Korea
Full Name of Sixth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Seventh Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Eighth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Ninth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Tenth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Eleventh Assignor	Assignor's Signature	Date
Address		Citizenship
Names of additional inventors attached <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No		

PATENT

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